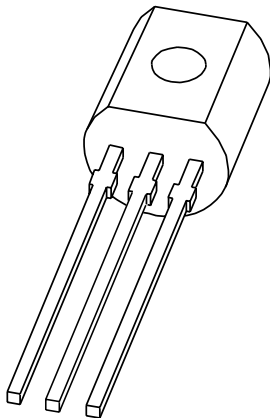


# DATA SHEET



## **BF483; BF485; BF487** NPN high-voltage transistors

Product specification  
Supersedes data of 1999 Apr 12

2004 Dec 08

# NPN high-voltage transistors

# BF483; BF485; BF487

### FEATURES

- Low feedback capacitance.

### APPLICATIONS

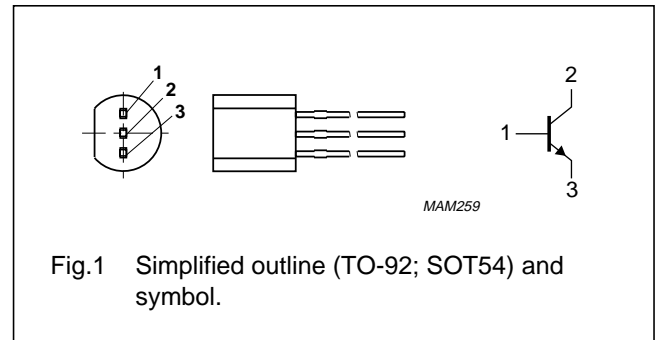
- Intended for use in video output stages in black-and-white and in colour television receivers.

### DESCRIPTION

NPN transistor in a TO-92; SOT54 plastic package.  
 PNP complement: BF488

### PINNING

PIN	DESCRIPTION
1	base
2	collector
3	emitter



### ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
BF483	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54
BF485			
BF487			

## NPN high-voltage transistors

## BF483; BF485; BF487

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter			
	BF483		–	300	V
	BF485		–	350	V
	BF487		–	400	V
V <sub>CEO</sub>	collector-emitter voltage	open base			
	BF483		–	250	V
	BF485		–	300	V
	BF487		–	350	V
V <sub>EBO</sub>	emitter-base voltage	open collector	–	5	V
I <sub>C</sub>	collector current (DC)		–	100	mA
I <sub>CM</sub>	peak collector current		–	200	mA
I <sub>BM</sub>	peak base current		–	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	–	830	mW
T <sub>stg</sub>	storage temperature		–65	+150	°C
T <sub>j</sub>	junction temperature		–	150	°C
T <sub>amb</sub>	ambient temperature		–65	+150	°C

**Note**

1. Transistor mounted on an FR4 printed-circuit board.

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	note 1	150	K/W

**Note**

1. Transistor mounted on an FR4 printed-circuit board.

**CHARACTERISTICS**T<sub>amb</sub> = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 300 V; I <sub>E</sub> = 0 A	–	20	nA
		V <sub>CB</sub> = 250 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C	–	20	μA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A	–	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 20 V			
		I <sub>C</sub> = 25 mA	50	–	
		I <sub>C</sub> = 40 mA	20	–	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 30 mA; I <sub>B</sub> = 5 mA	–	600	mV
C <sub>re</sub>	feedback capacitance	V <sub>CE</sub> = 30 V; I <sub>C</sub> = I <sub>c</sub> = 0 A; f = 1 MHz	–	1.4	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = –10 mA; f = 100 MHz	70	110	MHz

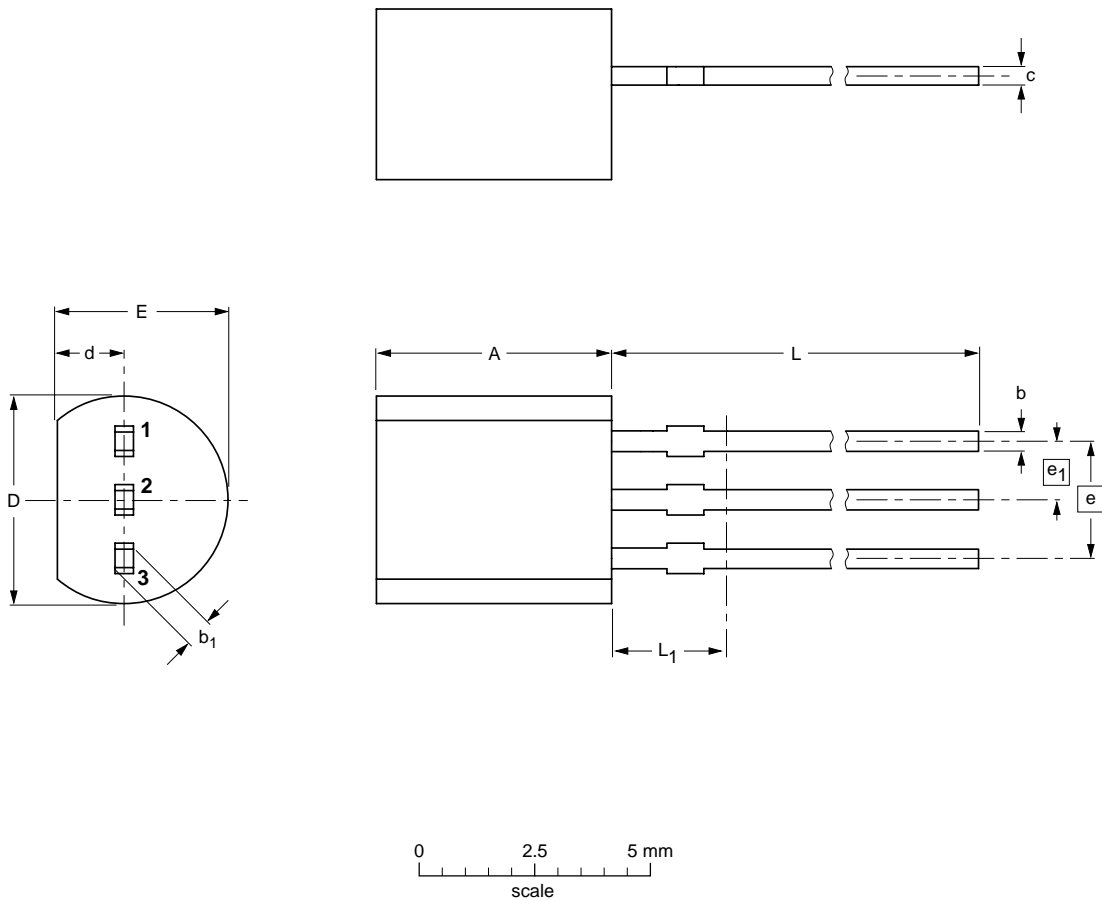
NPN high-voltage transistors

BF483; BF485; BF487

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b <sub>1</sub>	c	D	d	E	e	e <sub>1</sub>	L	L <sub>1</sub> <sup>(1)</sup> max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOT54		TO-92	SC-43A		<del>04-06-28</del> 04-11-16